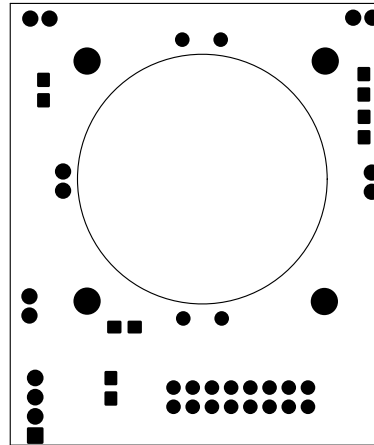
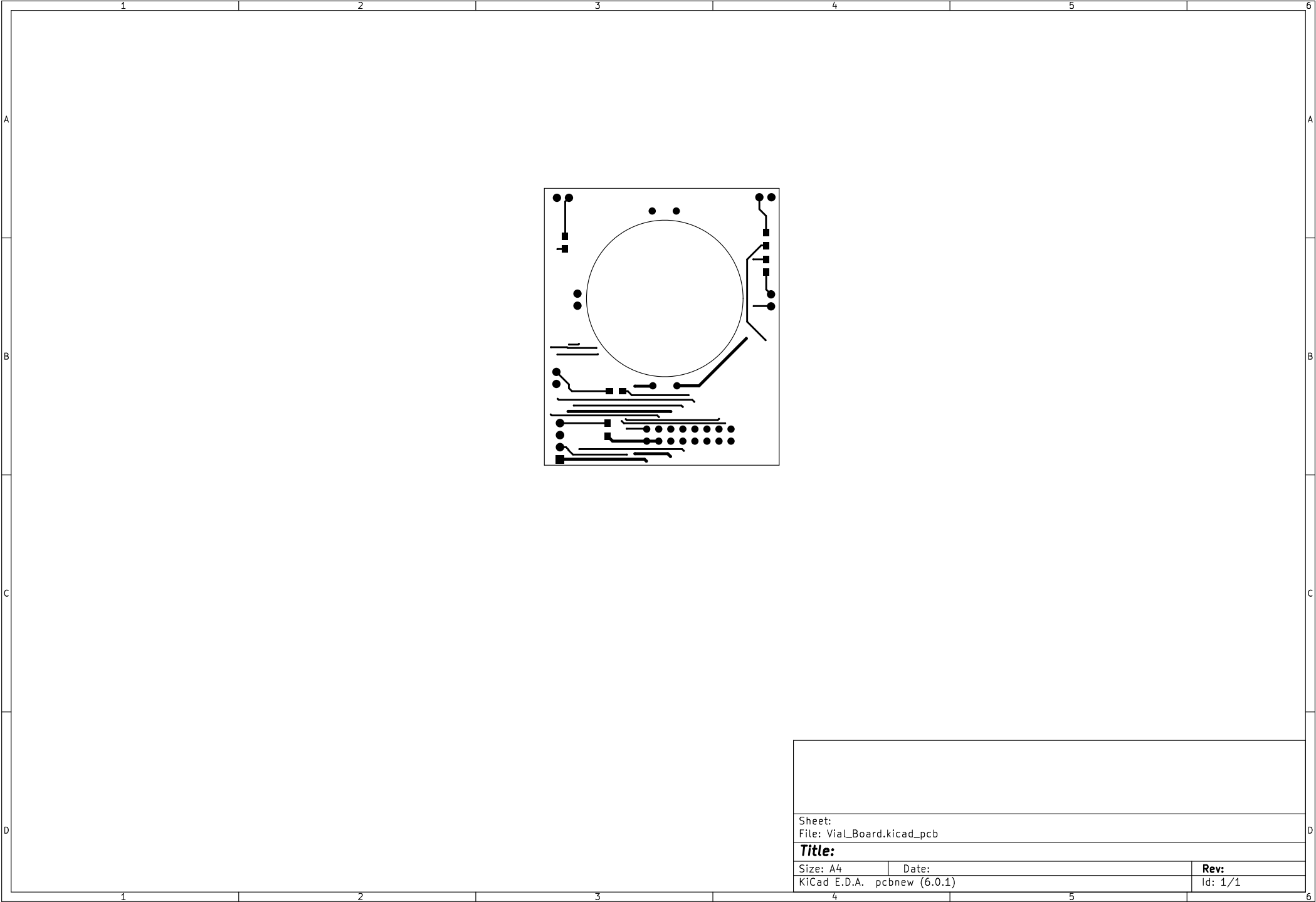


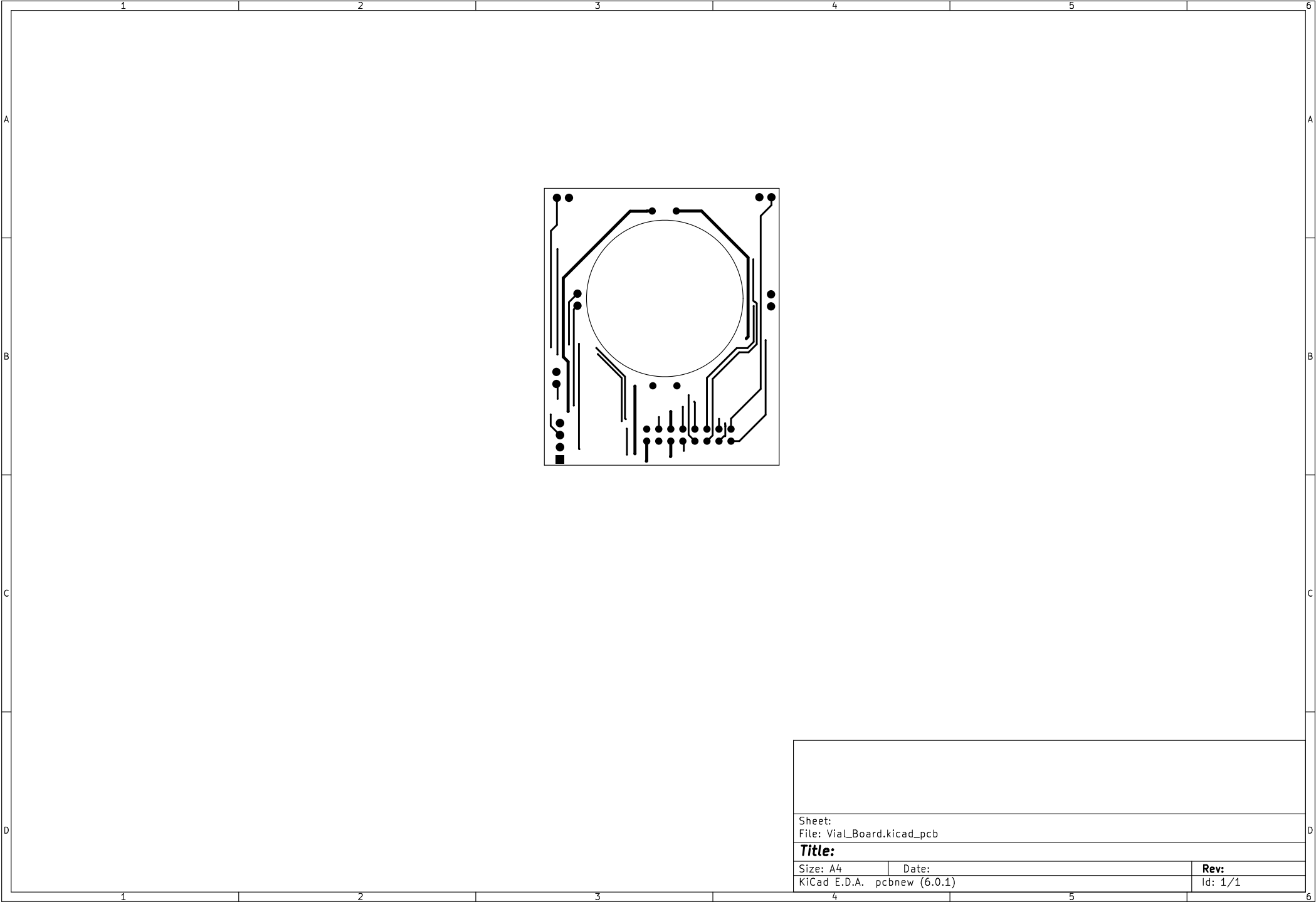
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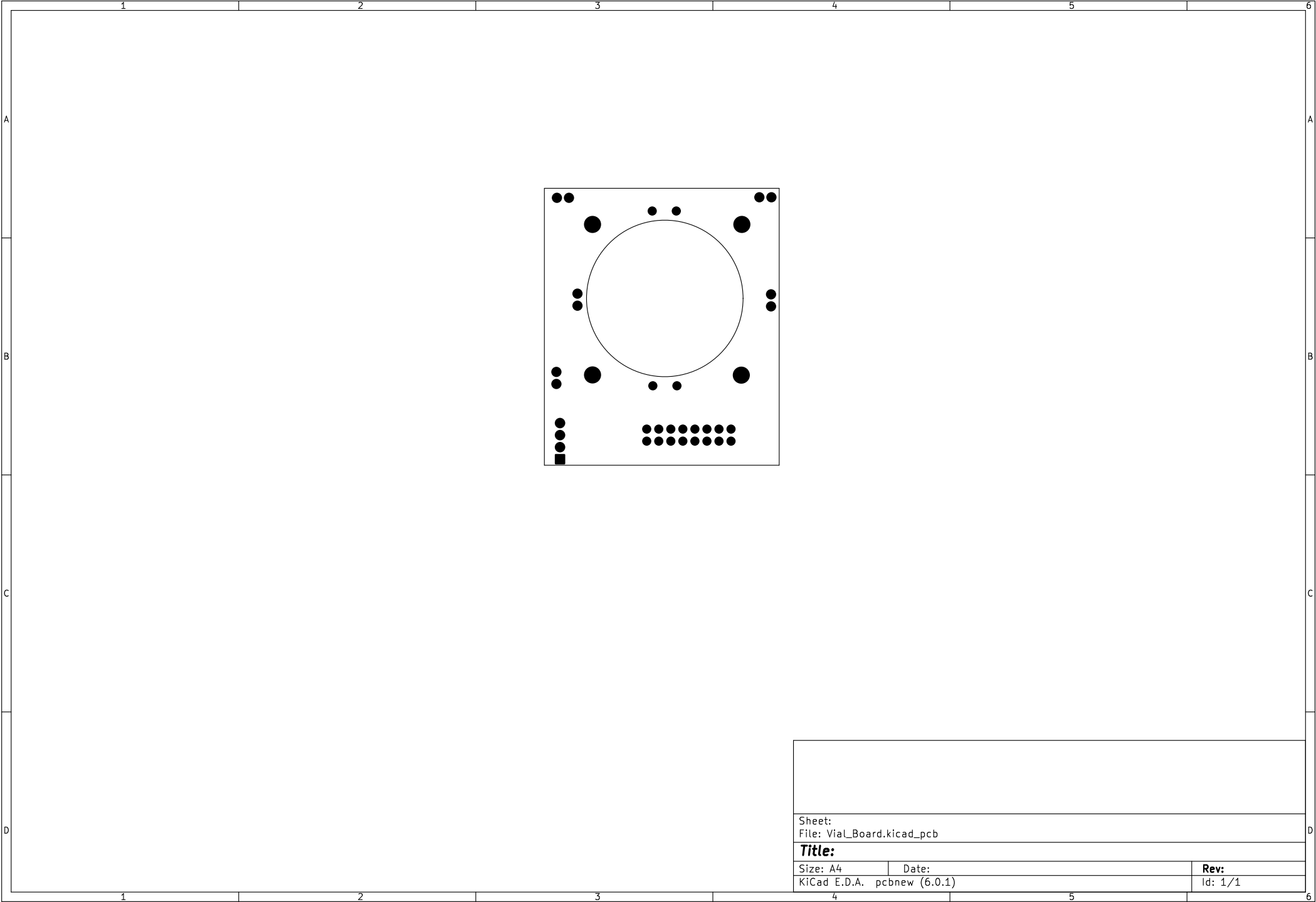
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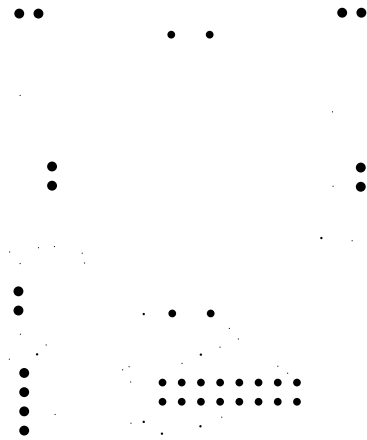
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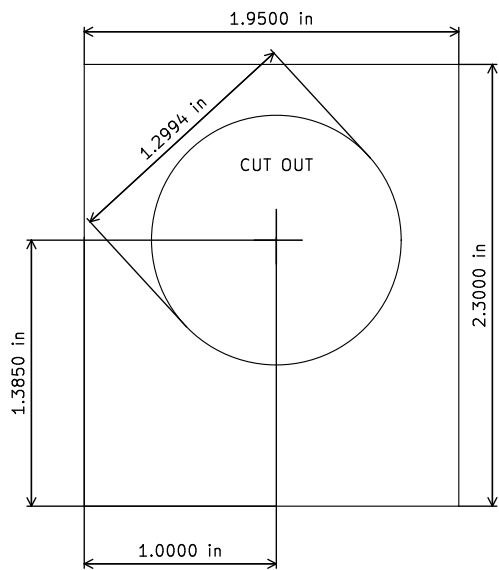


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Size: A4	Date:	Rev:
KiCad E.D.A. pcbnew (6.0.1)		Id: 1/1









BOSTON UNIVERSITY EDF
eVOLVER System

P/N EV-Vial Rev C
1 oz copper
2 Layers FR-4
0.063 final thickness
soldermask both sides (BLACK) <<-- NOTE: Black Solder Mask !!
1.300" cut-out @ (1.000", 1.3850") <<-- NOTE: Cutout !!
silkscreen legend top only (white)

Sheet:		
File: Vial_Board.kicad_pcb		
Title:		
Size: A4	Date:	Rev:
KiCad E.D.A. pcbnew (6.0.1)		Id: 1/1